Vishay Semiconductors

RoHS COMPLIANT

Three Phase Inverter Module in MTP Package 1200 V NPT IGBT and HEXFRED[®] Diodes, 5 A



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PRODUCT SUMMARY					
V _{CES}	1200 V				
$V_{CE(on)}$ typical at V_{GE} = 15 V	2.90 V				
I _C at T _C = 100 °C	5 A				
t _{sc} at T _J = 150 °C	> 10 µs				
Package	MTP				
Circuit	Three phase inverter				

FEATURES

- Generation 5 NPT 1200 V IGBT technology
- HEXFRED® diode with ultrasoft reverse recovery
- · Very low conduction and switching losses
- Optional SMT thermistor (NTC)
- Aluminum oxide DBC
- · Very low stray inductance design for high speed operation
- Short circuit 10 µs
- Square RBSOA
- Operating frequencies 8 kHz to 60 kHz
- UL approved file E78996
- · Designed and qualified for industrial level
- · Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

BENEFITS

- Optimized for inverter motor drive applications
- · Low EMI, requires less snubbing
- · Direct mounting to heatsink
- PCB solderable terminals
- Very low junction to case thermal resistance

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Collector to emitter voltage	V _{CES}		1200	V	
Continuous collector current		$T_{\rm C} = 25 \ ^{\circ}{\rm C}$	12		
	Ι _C	T _C = 100 °C	5		
Pulsed collector current	I _{CM}		24	А	
Peak switching current	I _{LM}		24	A	
Diode continuous forward current	I _F	T _C = 100 °C	5		
Peak diode forward current	I _{FM}		12		
Gate to emitter voltage	V_{GE}		± 20	V	
RMS isolation voltage	VISOL	Any terminal to case, t = 1 min	2500	v	
Maximum power dissipation (including diode and IGBT)	D	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$	76	W	
	P _D	T _C = 100 °C	31	vv	



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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Collector to emitter breakdown voltage	V _{(BR)CES}	$V_{GE} = 0 \text{ V}, \text{ I}_{C} = 250 \mu\text{A}$	1200	-	-	V
Temperature coefficient of V(BR)CES	$\Delta V_{(BR)CES} / \Delta T_J$	V _{GE} = 0 V, I _C = 1 mA (25 °C to 125 °C)	-	1.14	-	V/°C
		V _{GE} = 15 V, I _C = 6 A	-	2.90	3.17	
	Ň	V _{GE} = 15 V, I _C = 12 A	-	4.04	4.46	V
Collector to emitter voltage	V _{CE(on)}	$V_{GE} = 15 \text{ V}, \text{ I}_{C} = 6 \text{ A}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	3.45	3.60	
		V _{GE} = 15 V, I _C = 12 A, T _J = 125 °C	-	5.07	5.32	
Gate threshold voltage	V _{GE(th)}	I _C = 250 μA	4	-	6	
Temperature coefficient of threshold voltage	$\Delta V_{GE(th)} / \Delta T_J$	V_{CE} = V_{GE} , I_C = 1 mA (25 °C to 125 °C)	-	- 10	-	mV/°C
Forward transconductance	9 _{fe}	$V_{CE} = 25 \text{ V}, I_{C} = 6 \text{ A}$	-	3.2	-	S
Collector to emitter leaking current	I _{CES}	V _{GE} = 0 V, V _{CE} = 1200 V	-	-	250	<u> </u>
		$V_{GE} = 0 \text{ V}, V_{CE} = 1200 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$	-	-	1000	μA
Diode forward voltage drop	V _{FM}	I _F = 6 A, V _{GE} = 0 V	-	2.33	2.77	- v
		I _F = 12 A, V _{GE} = 0 V	-	3.01	3.63	
		$I_F = 6 \text{ A}, V_{GE} = 0 \text{ V}, T_J = 125 \text{ °C}$	-	2.55	2.98	
		$I_F = 12 \text{ A}, V_{GE} = 0 \text{ V}, T_J = 125 ^\circ\text{C}$	-	3.45	4.07	1
Gate to emitter leakage current	I _{GES}	V _{GE} = ± 20 V	-	-	± 250	nA

SWITCHING CHARACTERISTICS ($T_J = 25 \text{ °C}$ unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Total gate charge (turn-on)	Qg	I _C = 6 A	-	27	41		
Gate to emitter charge (turn-on)	Q _{ge}	V _{CC} = 600 V	-	3.7	5.6	nC	
Gate to collector charge (turn-on)	Q _{gc}	V _{GE} = 15 V	-	14	21		
Turn-on switching loss	E _{on}	$I_{C} = 6 \text{ A}, V_{CC} = 600 \text{ V}, V_{GE} = 15 \text{ V}$	-	0.606	0.909		
Turn-off switching loss	E _{off}	$R_g = 10 \Omega$, L = 2.0 mH, $T_J = 25 \degree C$ Energy losses include tail and	-	0.340	0.510	mJ	
Total switching loss	E _{tot}	diode reverse recovery	-	0.946	1.420		
Turn-on switching loss	Eon	$I_{C} = 6 \text{ A}, V_{CC} = 600 \text{ V}, V_{GE} = 15 \text{ V}$	-	0.779	1.170		
Turn-off switching loss	E _{off}	$R_g = 10 \Omega$, L = 2.0 mH, T _J = 125 °C Energy losses include tail and	-	0.403	0.605	mJ	
Total switching loss	E _{tot}	diode reverse recovery	-	1.182	1.775		
Turn-on delay time	t _{d(on)}		-	47	71	20	
Rise time	t _r	$I_{C} = 6 \text{ A}, V_{CC} = 600 \text{ V}, V_{GE} = 15 \text{ V}$	-	17	26		
Turn-off delay time	t _{d(off)}	L = 2.0 mH, L _S = 100 nH R _a = 10 Ω, T _J = 125 °C	-	99	150	ns	
Fall time	t _f		-	362	543		
Reverse BIAS safe operating area	RBSOA	T_J = 150 °C, I _C = 24 A R _g = 10 Ω, V _{GE} = 15 V to 0	Fullsquare				
Short circuit safe operating area	SCSOA	$V_{CC} = 600 \text{ V}, V_{GE} = + 15 \text{ V to } 0$ $T_J = 150 \text{ °C}, V_P = 1200 \text{ V}, R_g = 10 \Omega$	10	-	-	μs	
Input capacitance	C _{ies}	V _{GE} = 0 V	-	369	554		
Output capacitance	C _{oes}	$V_{CC} = 30 V$	-	244	366	pF	
Reverse transfer capacitance	C _{res}	f = 1 MHz	-	12	18		
Diode reverse recovery energy	E _{rec}	$I_{C} = 6 A, V_{CC} = 600 V, V_{GE} = 15 V$	-	334	-	μJ	
Diode reverse recovery time	t _{rr}	$L = 2.0 \text{ mH}, L_S = 100 \text{ nH}$	-	54	-	ns	
Diode peak reverse current	I _{rr}	R _g = 10 Ω, T _J = 125 °C	-	17	-	А	

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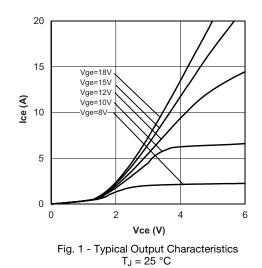
THERMISTOR SPECIFICATIONS (T CODE ONLY)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Resistance	R ₀ ⁽¹⁾	T ₀ = 25 °C	-	30	-	kΩ
Sensitivity index of the thermistor material	β (1)(2)	T ₀ = 25 °C T ₁ = 85 °C	-	4000	-	к

Notes

⁽¹⁾ T_0 , T_1 are thermistor's temperatures

⁽²⁾
$$\frac{R_0}{R_1} = \exp\left[\beta\left(\frac{1}{T_0} - \frac{1}{T_1}\right)\right]$$

THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Operating junction temperature range	TJ		- 40	-	150	°C
Storage temperature range	T _{Stg}		- 40	-	125	
Junction to case	D		-	-	2.68	
Diode	R _{thJC}		-	-	4.2	°C/W
Case to sink per module	R _{thCS}	Heatsink compound thermal conductivity = 1 W/mK	-	0.06	-	
Mounting torque			-	-	4	Nm
Weight			-	65	-	g



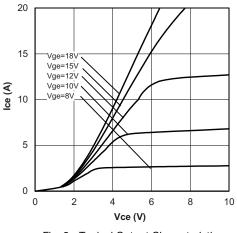
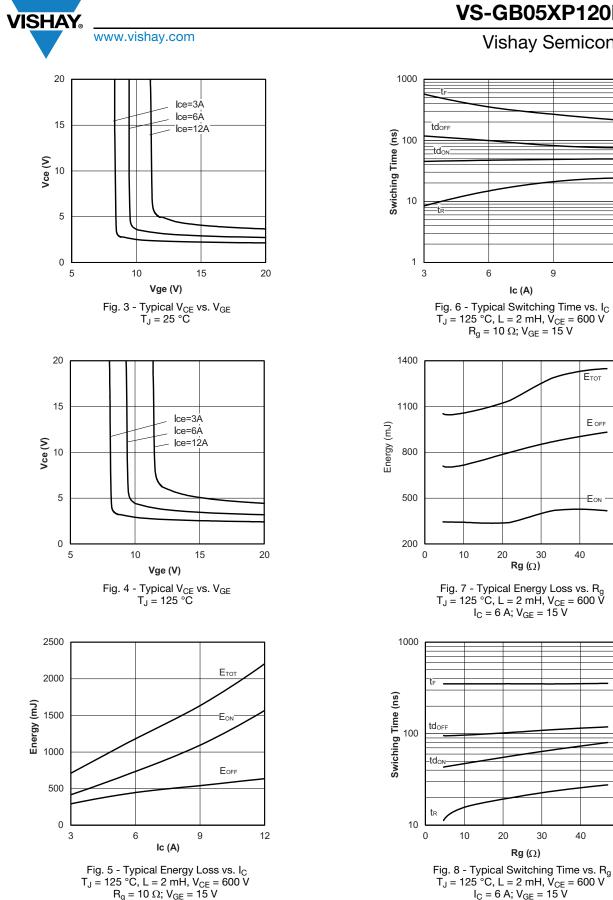


Fig. 2 - Typical Output Characteristics T_J = 125 $^\circ\text{C}$



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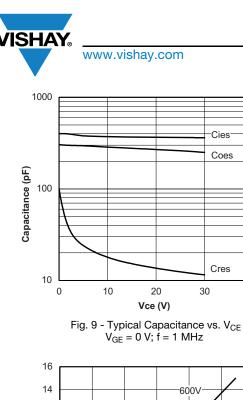
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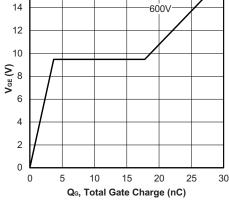
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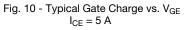
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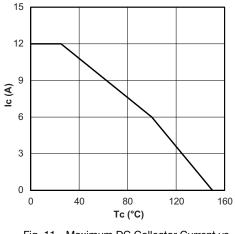
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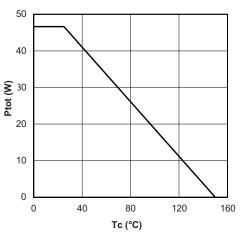
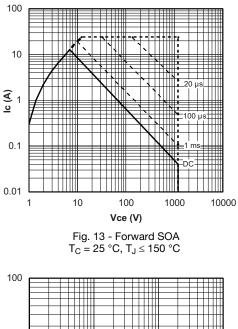


Fig. 12 - Power Dissipation vs. Case Temperature (IGBT only)



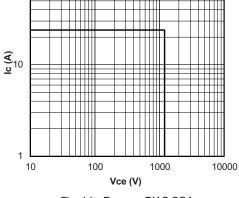


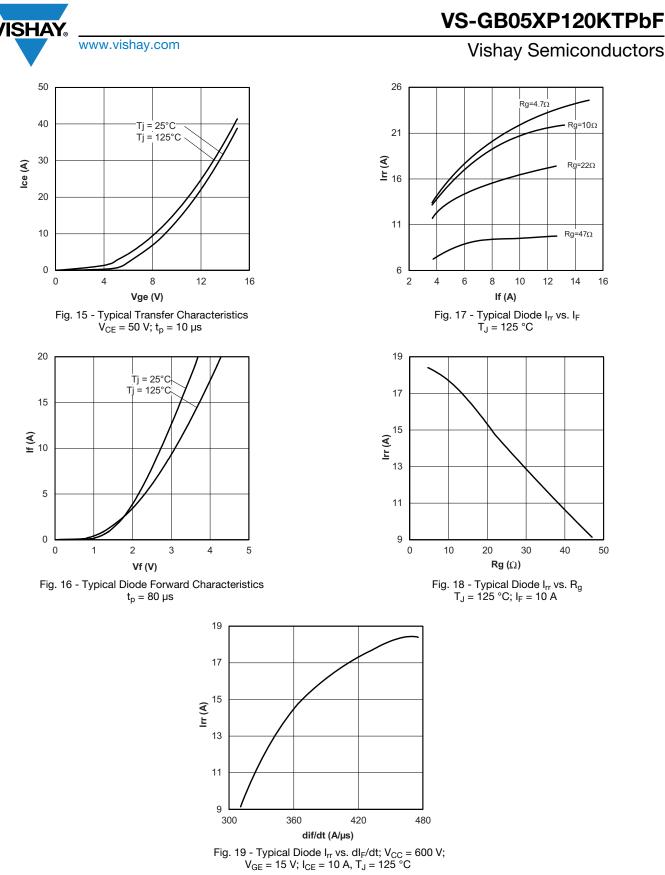
Fig. 14 - Reverse BIAS SOA T_{J} = 150 °C, V_{GE} = 15 V

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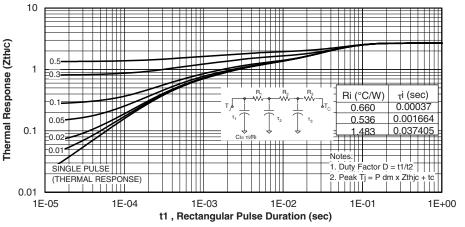


Fig. 20 - Maximum Transient Thermal Impedance, Junction to Case (IGBT)

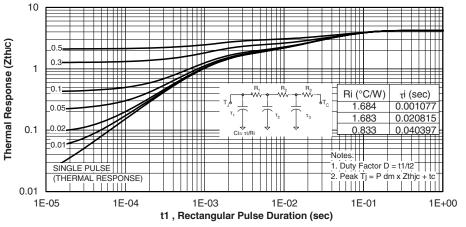


Fig. 21 - Maximum Transient Thermal Impedance, Junction to Case (Diode)

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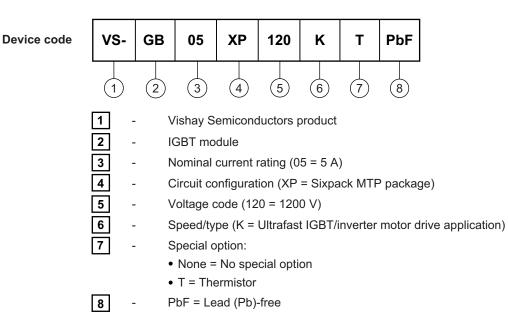
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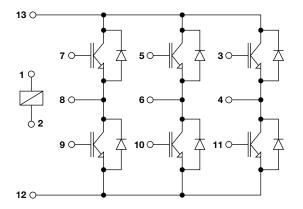


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CIRCUIT CONFIGURATION



LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95175			

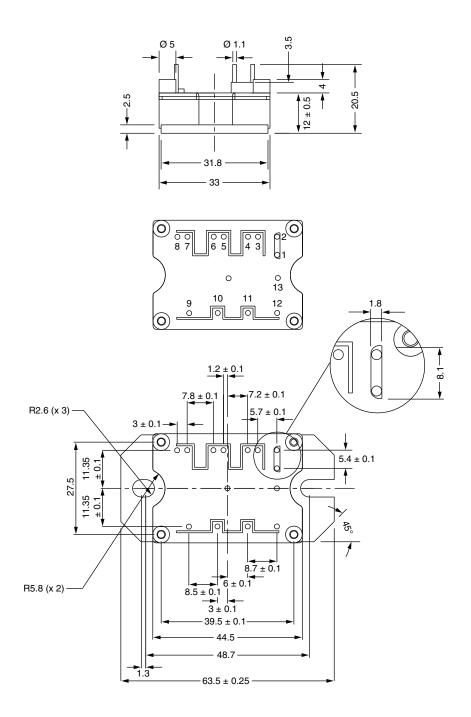
Outline Dimensions

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MTP

DIMENSIONS in millimeters



Note

• Unused terminals are not assembled in the package



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